<u>onsemi</u>

Schottky Barrier Rectifiers, Surface Mount, 1 A, 50 V - 150 V

SS15FA - S115FA

Features

- Low Power Loss, High Efficiency
- Guard Ring for Overvoltage Protection
- High Surge Current Capability
- UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- Green Molding Compound
- These Devices are Pb-Free and are RoHS Compliant



YYYY = Binary Calendar Year Code Scheme

= Assembly Plant Code

Ζ

W

- XXX = Specific Device Code
 - = Single Digit Week Code

ORDERING INFORMATION

Part Number	Device Code Marking	Package	Shipping [†]
SS15FA	15L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
SS16FA	16L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
SS19FA	19L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
S110FA	10L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
S115FA	1AL	SOD-123FL (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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SS15FA - S115FA

SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

		Value					
Symbol	Parameter	SS15FA	SS16FA	SS19FA	S110FA	S115FA	Unit
V _{RRM}	Repetitive Peak Reverse Voltage	50	60	90	100	150	V
V _{RMS}	RMS Reverse Voltage	35	42	63	70	105	V
V _R	DC Blocking Voltage	50	60	90	100	150	V
I _{F(AV)}	Average Forward Rectified Current	1		А			
I _{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine- Wave Superimposed on Rated Load	30		А			
TJ	Operating Junction Temperature Range	-55 to +150		°C			
T _{STG}	Storage Temperature Range	-55 to +150		°C			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (Note 1)

Symbol	Characteristic	Value	Unit
Ψ_{JL}	Junction-to-Lead Thermal Characteristics	16	°C/W
$R_{ hetaJA}$	Junction-to-Ambient Thermal Resistance	152	°C/W

1. Per JESD51-3 Recommended Thermal Test Board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

			Value					
Symbol	Parameter	Conditions	SS15FA	SS16FA	SS19FA	S110FA	S115FA	Unit
VF	Maximum Instantaneous Forward Voltage	I _F = 0.5 A	0.58		0.70 0.75		0.75	V
	(Note 2)	I _F = 1.0 A	0.70		0.80		0.90	
I _R	Maximum Reverse Current	$T_J = 25^{\circ}C$	0.4		0.05		mA	
	at Rated V _R	$T_J = 100^{\circ}C$	6.0		-			
		T _J = 125°C	-		0.5			
CJ	Typical Junction Capacitance	V _R = 4 V, f = 1 MHz	54		54 35			pF
T _{rr}	Typical Reverse Recovery Time	I _F = 0.5 A, I _R = 1 A, I _{RR} = 0.25 A	5.6 8.3			ns		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse test with PW = $300 \ \mu s$, 1% duty cycle.

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TYPICAL PERFORMANCE CHARACTERISTICS



Figure 1. Forward Current Derating Curve



Figure 2. Maximum Non-Repetitive Forward Surge Current



Figure 3. Typical Forward Characteristics



V_F - FORWARD VOLTAGE (V)





Figure 4. Typical Forward Characteristics



Figure 6. Typical Reverse Characteristics

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TYPICAL PERFORMANCE CHARACTERISTICS (continued)



Figure 7. Typical Reverse Characteristics



Figure 8. Typical Junction Capacitance







А





FRONT VIEW



BOTTOM VIEW

SOD-123FA CASE 425AB ISSUE A

DATE 11 AUG 2022

NDTES

- 1. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.
- 3. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND THE BAR PROTRUSIONS.

DIM	MILLIMETERS				
MIU	MIN. NDM.		MAX.		
A	1.23	1.33	1.43		
b	0,80	1.00	1.20		
C	0.16	0.23	0.30		
D	2.70	2,80	2.90		
D1	3.40	3,60	3.80		
E	1.70	1.80	1.90		
He	2.45		2.60		
L	0.35	0.60	0.85		



MOUNTING FOOTPRINT*

* For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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